CMOS Digital Integrated Circuits Silicon Monolithic

74VHC161FT,74VHC163FT

1. Functional Description

• Synchronous Presettable 4-Bit Counter 74VHC161FT: Binary , Asynchronous Clear 74VHC163FT: Binary , Synchronous Clear

2. General

The 74VHC161FT and 74VHC163FT are advanced high speed CMOS SYNCHRONOUS PRESETTABLE 4 BIT BINARY COUNTERs fabricated with silicon gate C²MOS technology.

They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The CK input is active on the rising edge. Both $\overline{\text{LOAD}}$ and $\overline{\text{CLR}}$ inputs are active on low logic level.

Presetting of each IC's is synchronous to the rising edge of CK.

The clear function of the 74VHC163FT is synchronous to CK, while the 74VHC161FT are cleared asynchronously. Two enable inputs (ENP and ENT) and CARRY OUTPUT are provided to enable easy cascading of counters, which facilitates easy implementation of n-bit counters without using external gates.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages

3. Features

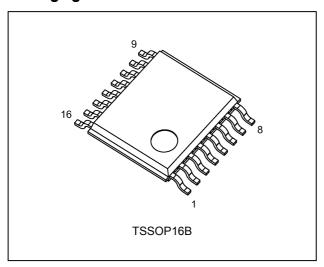
- (1) AEC-Q100 (Rev. H) (Note 1)
- (2) Wide operating temperature range: $T_{opr} = -40$ to 125 °C
- (3) High speed: $f_{MAX} = 185 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- (4) Low power dissipation: $I_{CC} = 4.0 \mu A \text{ (max)}$ at $T_a = 25 \text{ °C}$
- (5) High noise immunity: $V_{NIH} = V_{NIL} = 28 \% V_{CC}$ (min)
- (6) Power-down protection is provided on all inputs.
- (7) Balanced propagation delays: t_{PLH} ≈ t_{PHL}
- (8) Wide operating voltage range: $V_{CC(opr)} = 2.0 \text{ V}$ to 5.5 V
- (9) Low noise: VOLP=0.8 V (max)
- (10) Pin and function compatible with 74 series (AC/HC/AHC/LV etc.) 161 or 163 type.

Note 1: This device is compliant with the reliability requirements of AEC-Q100. For details, contact your Toshiba sales representative.

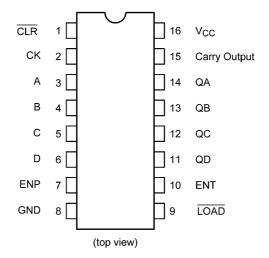
Rev.3.0



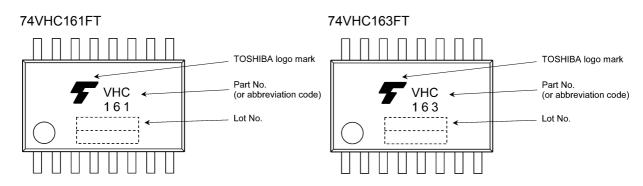
4. Packaging



5. Pin Assignment



6. Marking

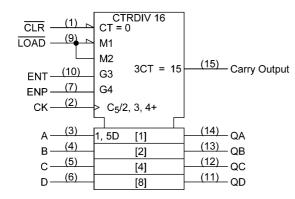


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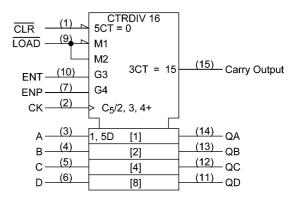


7. IEC Logic Symbol

74VHC161FT



74VHC163FT



8. Truth Table

	74	VHC161	FT			74	VHC163	FT		Outputs				
		Inputs			Inputs				Outputs				Function	
CLR	LOAD	ENP	ENT	СК	CLR	LOAD	ENP	ENT	СК	QA	QA QB QC QD			
L	Х	Х	Х	Х	L	Х	Х	Х		L	L	L	L	Reset to "0"
Н	L	Х	Х		Н	L	Х	Х		Α	В	С	D	Preset Data
Н	Н	Х	L		Н	Н	Х	L		No Cha	ange			No Count
Н	Н	L	Х		Н	Н	L	Х		No Cha	ange			No Count
Н	Н	Н	Н		Н	Н	Н	Н		Count Up				Count
Н	Х	Х	Х		Х	Х	Х	Х	-	No Cha	ange			No Count

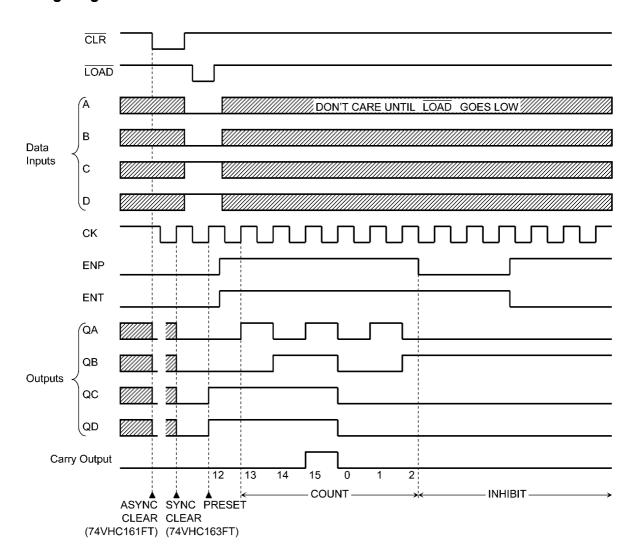
X: Don't care

A, B, C, D: Logic level of data inputs

Carry: Carry = ENT \cdot QA \cdot QB \cdot QC \cdot QD

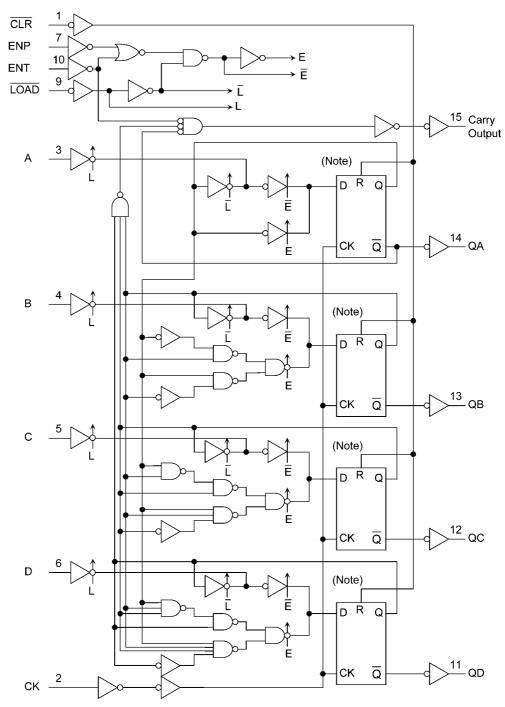


9. Timing Diagrams





10. System Diagram



Note: Truth table of internal F/F

	74	VHC161	FT		74VHC163FT						
D	СК	R	Q	Q	D	СК	R	Q	Q		
Х	Х	Н	L	Н	Х		Н	L	Н		
L		L	L	Н	L		L	L	Н		
Н		L	Н	L	Н		L	Н	L		
Х		L	No CI	nange	Х	X X No Char					

X: Don't care



11. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 7.0	V
Input voltage	V _{IN}		-0.5 to 7.0	V
Output voltage	V _{OUT}		-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}		-20	mA
Output diode current	I _{OK}		±20	mA
Output current	l _{out}		±25	mA
V _{CC} /ground current	I _{CC}		±50	mA
Power dissipation	P _D	(Note 1)	180	mW
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: 180 mW in the range of T_a = -40 to 85 °C. From T_a = 85 to 125 °C a derating factor of -3.25 mW/°C shall be applied until 50 mW.

12. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Rating	Unit
Supply voltage	V _{CC}		2.0 to 5.5	V
Input voltage	V _{IN}		0 to 5.5	V
Output voltage	V _{OUT}		0 to V _{CC}	V
Operating temperature	T _{opr}		-40 to 125	°C
Input rise and fall times	dt/dv	V_{CC} = 3.3 ± 0.3 V	0 to 100	ns/V
		V _{CC} = 5 ± 0.5 V	0 to 20	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.



13. Electrical Characteristics

13.1. DC Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	_	V
				3.0 to 5.5	$V_{CC} \times 0.7$	_	_	
Low-level input voltage	V _{IL}	_		2.0	_		0.50	V
				3.0 to 5.5	_		$V_{CC} \times 0.3$	
High-level output voltage	V _{OH}	$V_{IN} = V_{IH}$ or V_{IL}	I_{OH} = -50 μ A	2.0	1.9	2.0	_	V
				3.0	2.9	3.0	_	
				4.5	4.4	4.5	_	
			I_{OH} = -4 mA	3.0	2.58	_	_	
			I_{OH} = -8 mA	4.5	3.94		_	
Low-level output voltage	V _{OL}	$V_{IN} = V_{IH}$ or V_{IL}	I _{OL} = 50 μA	2.0	_	0.0	0.1	V
				3.0	_	0.0	0.1	
				4.5	_	0.0	0.1	
			I_{OL} = 4 mA	3.0	_	_	0.36	
			I _{OL} = 8 mA	4.5	_	_	0.36	
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5			±0.1	μΑ
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC}$ or GND		5.5	_	_	4.0	μΑ

13.2. DC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

Characteristics	Symbol	Test Cond	dition	V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	V
				3.0 to 5.5	$V_{CC} \times 0.7$	_	
Low-level input voltage	V _{IL}	_	·	2.0	_	0.50	٧
				3.0 to 5.5	_	$V_{CC} \times 0.3$	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	2.0	1.9	_	٧
				3.0	2.9	_	
				4.5	4.4	_	
			$I_{OH} = -4 \text{ mA}$	3.0	2.48	_	
			$I_{OH} = -8 \text{ mA}$	4.5	3.80	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0	_	0.1	٧
				3.0	_	0.1	
				4.5	_	0.1	
			I _{OL} = 4 mA	3.0	_	0.44	
			I _{OL} = 8 mA	4.5	_	0.44	
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5		±1.0	μΑ
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		5.5		40.0	μА



13.3. DC Characteristics (Unless otherwise specified, T_a = -40 to 125 °C)

Characteristics	Symbol	Test Condit	ion	V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	V
				3.0 to 5.5	$V_{CC} \times 0.7$	_	
Low-level input voltage	V _{IL}	_		2.0	_	0.50	V
				3.0 to 5.5	_	$V_{CC} \times 0.3$	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	2.0	1.9	_	٧
				3.0	2.9	_	
				4.5	4.4	_	
			$I_{OH} = -4 \text{ mA}$	3.0	2.40	_	
			I _{OH} = -8 mA	4.5	3.70	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0	_	0.1	٧
				3.0	_	0.1	
				4.5	_	0.1	
			I _{OL} = 4 mA	3.0	_	0.55	
			I _{OL} = 8 mA	4.5	_	0.55	
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5		±2.0	μА
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND		5.5	_	80.0	μΑ

13.4. Timing Requirements (Unless otherwise specified, $T_a = 25$ °C, Input: $t_f = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width	$t_{w(L)}, t_{w(H)}$		Figure 1	3.3 ± 0.3	5.0	ns
(CK)				5.0 ± 0.5	5.0	
Minimum pulse width	t _{w(L)}	(Note 1)	Figure 4	3.3 ± 0.3	5.0	ns
(CLR)				5.0 ± 0.5	5.0	
Minimum setup time	t _S		Figure 2	3.3 ± 0.3	5.5	ns
(A,B,C,D)				5.0 ± 0.5	4.5	
Minimum setup time	t _S		Figure 2	3.3 ± 0.3	8.0	ns
(LOAD)				5.0 ± 0.5	5.0	
Minimum setup time	t _S		Figure 3	3.3 ± 0.3	7.5	ns
(ENT,ENP)				5.0 ± 0.5	5.0	
Minimum setup time	t _S	(Note 2)	Figure 5	3.3 ± 0.3	4.0	ns
(CLR)				5.0 ± 0.5	3.5	
Minimum hold time	t _h		Figure 2, Figure 3	3.3 ± 0.3	1.0	ns
				5.0 ± 0.5	1.0	
Minimum hold time	t _h	(Note 2)	Figure 5	3.3 ± 0.3	1.0	ns
(CLR)				5.0 ± 0.5	1.5	
Minimum removal time	t _{rem}	(Note 1)	Figure 4	3.3 ± 0.3	2.5	ns
(CLR)				5.0 ± 0.5	1.5	

Note 1: For 74VHC161FT only Note 2: For 74VHC163FT only



13.5. Timing Requirements (Unless otherwise specified, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width	$t_{w(L)}, t_{w(H)}$		Figure 1	3.3 ± 0.3	5.0	ns
(CK)				5.0 ± 0.5	5.0	
Minimum pulse width	t _{w(L)}	(Note 1)	Figure 4	3.3 ± 0.3	5.0	ns
(CLR)				5.0 ± 0.5	5.0	
Minimum setup time	t _S		Figure 2	3.3 ± 0.3	6.5	ns
(A,B,C,D)				5.0 ± 0.5	4.5	
Minimum setup time	t _S		Figure 2	3.3 ± 0.3	9.5	ns
(LOAD)				5.0 ± 0.5	6.0	
Minimum setup time	t _S		Figure 3	3.3 ± 0.3	9.0	ns
(ENT,ENP)				5.0 ± 0.5	6.0	
Minimum setup time	t _S	(Note 2)	Figure 5	3.3 ± 0.3	4.0	ns
(CLR)				5.0 ± 0.5	3.5	
Minimum hold time	t _h		Figure 2, Figure 3	3.3 ± 0.3	1.0	ns
				5.0 ± 0.5	1.0	
Minimum hold time	t _h	(Note 2)	Figure 5	3.3 ± 0.3	1.0	ns
(CLR)				5.0 ± 0.5	1.5	
Minimum removal time	t _{rem}	(Note 1)	Figure 4	3.3 ± 0.3	2.5	ns
(CLR)				5.0 ± 0.5	1.5	

Note 1: For 74VHC161FT only Note 2: For 74VHC163FT only

13.6. Timing Requirements (Unless otherwise specified, $T_a = -40$ to 125 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width	$t_{w(L)}, t_{w(H)}$		Figure 1	3.3 ± 0.3	5.0	ns
(CK)				5.0 ± 0.5	5.0	
Minimum pulse width	t _{w(L)}	(Note 1)	Figure 4	3.3 ± 0.3	5.0	ns
(CLR)				5.0 ± 0.5	5.0	
Minimum setup time	t _S		Figure 2	3.3 ± 0.3	6.5	ns
(A,B,C,D)				5.0 ± 0.5	4.5	
Minimum setup time	t _S		Figure 2	3.3 ± 0.3	9.5	ns
(LOAD)				5.0 ± 0.5	6.0	
Minimum setup time	t _S		Figure 3	3.3 ± 0.3	9.0	ns
(ENT,ENP)				5.0 ± 0.5	6.0	
Minimum setup time	t _S	(Note 2)	Figure 5	3.3 ± 0.3	4.0	ns
(CLR)				5.0 ± 0.5	3.5	
Minimum hold time	t _h		Figure 2, Figure 3	3.3 ± 0.3	1.0	ns
				5.0 ± 0.5	1.0	
Minimum hold time	t _h	(Note 2)	Figure 5	3.3 ± 0.3	1.0	ns
(CLR)				5.0 ± 0.5	1.5	
Minimum removal time	t _{rem}	(Note 1)	Figure 4	3.3 ± 0.3	3.5	ns
(CLR)				5.0 ± 0.5	2.0	

Note 1: For 74VHC161FT only Note 2: For 74VHC163FT only



13.7. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}		Figure 1,	3.3 ± 0.3	15	_	8.3	12.8	ns
(CK - Q)			Figure 2		50	_	10.8	16.3	
				5.0 ± 0.5	15	_	4.9	8.1	
					50		6.4	10.1	
Propagation delay time	t _{PLH} ,t _{PHL}		Figure 1	3.3 ± 0.3	15	_	8.7	13.6	ns
(CK - CARRY , count-mode)					50	_	11.2	17.1	
				5.0 ± 0.5	15	_	4.9	8.1	
					50	_	6.4	10.1	
Propagation delay time	t _{PLH} ,t _{PHL}		Figure 2	3.3 ± 0.3	15	_	11.0	17.2	ns
(CK - CARRY , preset-mode)					50	_	13.5	20.7	
				5.0 ± 0.5	15	_	6.2	10.3	
					50	_	7.7	12.3	
Propagation delay time	t _{PLH} ,t _{PHL}		Figure 6	3.3 ± 0.3	15	_	7.5	12.3	ns
(ENT - CARRY)					50	_	10.5	15.8	
				5.0 ± 0.5	15	_	4.9	8.1	
					50	_	6.4	10.1	
Propagation delay time	t _{PHL}	(Note 1)	Figure 4	3.3 ± 0.3	15	_	8.9	13.6	ns
(CLR - Q)					50	_	11.2	17.1	
				5.0 ± 0.5	15		5.5	9.0	
					50	_	7.0	11.0	
Propagation delay time	t _{PHL}	(Note 1)	Figure 4	3.3 ± 0.3	15	_	8.4	13.2	ns
(CLR - CARRY)					50	_	10.9	16.7	
				5.0 ± 0.5	15	_	5.0	8.6	
					50		6.5	10.6	
Maximum clock frequency	f _{MAX}		_	3.3 ± 0.3	15	80	130	_	MHz
					50	55	85	_	
				5.0 ± 0.5	15	135	185	_	
					50	95	125	_	
Input capacitance	C _{IN}		_			_	4	10	pF
Power dissipation capacitance	C _{PD}	(Note 2)	_			_	23	_	pF

Note 1: For 74VHC161FT only

Note 2: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}$$

When the outputs drive a capacitive load, total current consumption is the sum of $I_{CC(opr)}$ and ΔI_{CC} which is obtained from the following formula:

$$\Delta I_{CC} = f_{CK} \times V_{CC} \times (C_{QA}/2 + C_{QB}/4 + C_{QC}/8 + C_{QD}/16 + C_{CO}/16)$$

 C_{QA} to C_{QD} and C_{CO} are the capacitances at QA to QD and Carry out, respectively. f_{CK} is the input frequency of the CK.



13.8. AC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	C _L (pF)	Min	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}		Figure 1, Figure 2	3.3 ± 0.3	15	1.0	15.0	ns
(CK - Q)					50	1.0	18.5	
				5.0 ± 0.5	15	1.0	9.5	
					50	1.0	11.5	
Propagation delay time	t _{PLH} ,t _{PHL}		Figure 1	3.3 ± 0.3	15	1.0	16.0	ns
(CK - CARRY , count-mode)					50	1.0	19.5	
				5.0 ± 0.5	15	1.0	9.5	
					50	1.0	11.5	
Propagation delay time	t _{PLH} ,t _{PHL}		Figure 2	3.3 ± 0.3	15	1.0	20.0	ns
(CK - CARRY , preset-mode)					50	1.0	23.5	
				5.0 ± 0.5	15	1.0	12.0	
					50	1.0	14.0	
Propagation delay time	t _{PLH} ,t _{PHL}		Figure 6	3.3 ± 0.3	15	1.0	14.5	ns
(ENT - CARRY)					50	1.0	18.0	
				5.0 ± 0.5	15	1.0	9.5	
					50	1.0	11.5	
Propagation delay time	t _{PHL}	(Note 1)	Figure 4	3.3 ± 0.3	15	1.0	16.0	ns
(CLR - Q)					50	1.0	19.5	
				5.0 ± 0.5	15	1.0	10.5	
					50	1.0	12.5	
Propagation delay time	t _{PHL}	(Note 1)	Figure 4	3.3 ± 0.3	15	1.0	15.5	ns
(CLR - CARRY)					50	1.0	19.0	
				5.0 ± 0.5	15	1.0	10.0	
					50	1.0	12.0	
Maximum clock frequency	f _{MAX}		_	3.3 ± 0.3	15	70	_	MHz
					50	50	_	
				5.0 ± 0.5	15	115	_	
					50	85	_	
Input capacitance	C _{IN}		_	•		_	10	pF

Note 1: For 74VHC161FT only



13.9. AC Characteristics (Unless otherwise specified, T_a = -40 to 125 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	C _L (pF)	Min	Max	Unit
Propagation delay time (CK - Q)	t _{PLH} ,t _{PHL}		Figure 1, Figure 2	3.3 ± 0.3	15	1.0	17.0	ns
					50	1.0	20.5	
				5.0 ± 0.5	15	1.0	11.0	
					50	1.0	13.0	
Propagation delay time (CK - CARRY , count-mode)	t _{PLH} ,t _{PHL}		Figure 1	3.3 ± 0.3 5.0 ± 0.5	15	1.0	18.0	ns
					50	1.0	21.5	
					15	1.0	11.0	
					50	1.0	13.0	
Propagation delay time (CK - CARRY , preset-mode)	t _{PLH} ,t _{PHL}		Figure 2	3.3 ± 0.3 5.0 ± 0.5	15	1.0	22.5	ns
					50	1.0	26.0	
					15	1.0	13.5	
					50	1.0	15.5	
Propagation delay time (ENT - CARRY)	t _{PLH} ,t _{PHL}		Figure 6	3.3 ± 0.3	15	1.0	16.5	ns
					50	1.0	20.0]
				5.0 ± 0.5	15	1.0	11.0	
					50	1.0	13.0	
Propagation delay time (CLR - Q)	t _{PHL}	(Note 1)	Figure 4	3.3 ± 0.3	15	1.0	18.0	ns
					50	1.0	21.5	
				5.0 ± 0.5	15	1.0	12.0	
					50	1.0	14.0	
Propagation delay time (CLR - CARRY)	t _{PHL}	(Note 1)	Figure 4	3.3 ± 0.3	15	1.0	17.5	ns
					50	1.0	21.0	
				5.0 ± 0.5	15	1.0	11.5	
					50	1.0	13.5	
Maximum clock frequency	f _{MAX}		_	3.3 ± 0.3	15	60		MHz
					50	40	_	
				5.0 ± 0.5	15	105	_	
					50	75	_	
Input capacitance	C _{IN}					1	10	pF

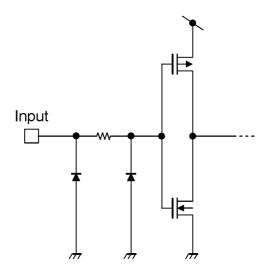
Note 1: For 74VHC161FT only



14. Noise Characteristics (Unless otherwise specified, T_a = 25 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Limit	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	C _L = 50 pF	5.0	0.4	0.8	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	C _L = 50 pF	5.0	-0.4	-0.8	V
Minimum high-level dynamic input voltage	V _{IHD}	C _L = 50 pF	5.0		3.5	V
Maximum low-level dynamic input voltage	V_{ILD}	C _L = 50 pF	5.0		1.5	V

15. Internal Equivalent Circuit





QA to QD,

Carry Output

16. AC Characteristics Test Waveform

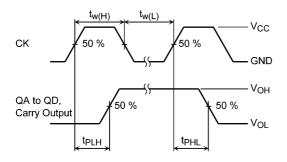


Figure 1 Count Mode

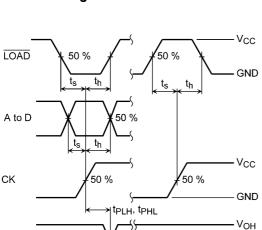


Figure 2 Preset Mode

- VoL

50 %

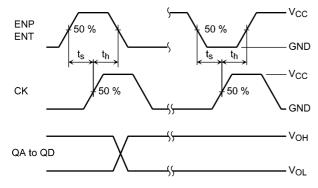


Figure 3 Count Enable Mode

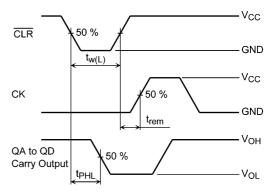


Figure 4 Clear Mode (74VHC161FT)

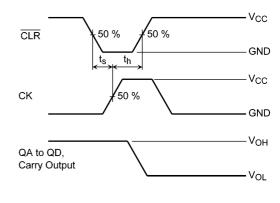


Figure 5 Clear Mode (74VHC163FT)

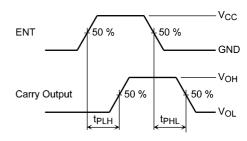
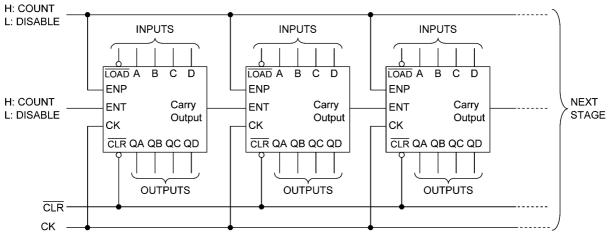


Figure 6 Cascade Mode (fix maximum count)



17. Typical Application

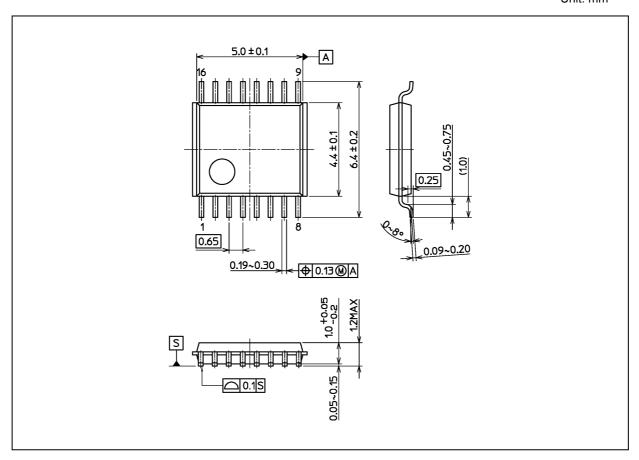


Parallel Carry N-Bit Counter



Package Dimensions

Unit: mm



Weight: 0.055 g (typ.)

	Package Name(s)	
Nickname: TSSOP16B		



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